



DLPA004 DATA BUS TRANSIENT SUPPRESSOR

Features

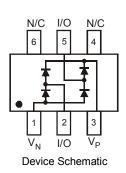
- Fast Switching Speed
- Ultra-Small Surface Mount Package
- IEC 61000-4-2 Contact Method: ±15kV
- IEC 61000-4-2 Air Discharge Method: ±25kV
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Qsuffix) part. A listing can be found at https://www.diodes.com/products/automotive/automotiveproducts/.
- This part is qualified to JEDEC standards (as references in AEC-Q) for High-Reliability. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Case: SOT-363
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish—Matte Tin annealed over Alloy 42 Lead-Frame. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.006 grams (Approximate)



Top View



Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
DLPA004-7	Standard	SOT-363	3000/Tape & Reel

SOT-363

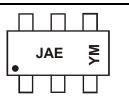
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



JAE = Product Type Marking Code YM = Date Code Marking Y = Year (ex: V = 2020) M = Month (ex: 9 = September)

Date Code Key

Date Code Rey												
Year	2008	3		2020		2021	2022	2	2023	2024		2025
Code	V			Н			J		К	L		М
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings @ $T_A = 25^{\circ}C$ unless otherwise specified

Characteristic		Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	85	V		
RMS Reverse Voltage		V _{R(RMS)}	60	V	
Forward Current (Single Diode)		I _{FM}	200	mA	
Repetitive Peak Forward Current		I _{FRM}	450	mA	
Non-Repetitive Peak Forward Surge Current	@ t = 1.0µs @ t = 1.0ms @ t = 1.0s	I _{FSM}	4.0 1.0 0.5	A	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	200	mW
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{ heta}JA$	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	85	_	—	V	I _R = 100μA
Forward Voltage	V _F	_	_	0.80 0.90 1.0 1.25	v	I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA
Leakage Current (Note 6)	I _R	_	_	2.5 30 50	μA	V _R = 70V V _R = 25V, T _J = 150°C V _R = 70V, T _J = 150°C
Total Capacitance (per element)		_	2	—	pF	V _R = 0, f = 1.0MHz
Capacitance Between Two Data Lines (DL1 & DL2, DL1 & DL3)	C _{LL}	_	1.6	2.0	pF	V _R = 0, f = 1.0MHz
Capacitance Between Data Line and Ground	C _{LG}	_	2.3	3.0	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	trr	_	_	3.0	μs	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

Notes:5. Device mounted on FR-4 PCB, 1.5 inch x 1.5 inch; 2oz copper with 1" x 1" pad layout.6. Short duration pulse test used to minimize self-heating effect.



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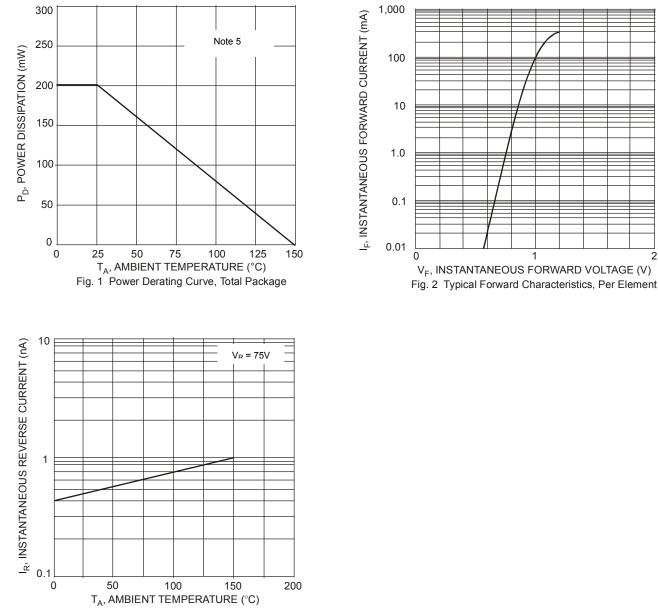
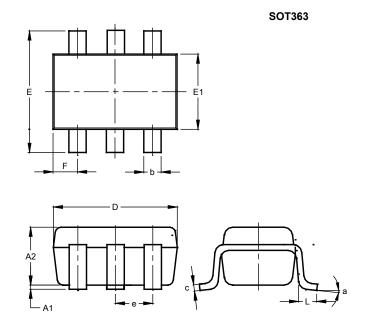


Fig. 3 Typical Reverse Characteristics, Per Element



Package Outline Dimensions

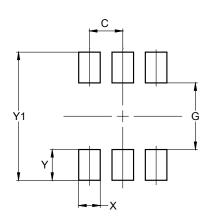
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT363							
Dim	Min	Max	Тур				
A1	0.00	0.10	0.05				
A2	0.90	1.00	0.95				
b	0.10	0.30	0.25				
C	0.10	0.22	0.11				
D	1.80	2.20	2.15				
ш	2.00	2.20	2.10				
E1	1.15	1.35	1.30				
e	0.650 BSC						
F	0.40	0.45	0.425				
1	0.25	0.40	0.30				
а	0°	8°					
All I	All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.650
G	1.300
Х	0.420
Y	0.600
Y1	2.500

SOT363



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